

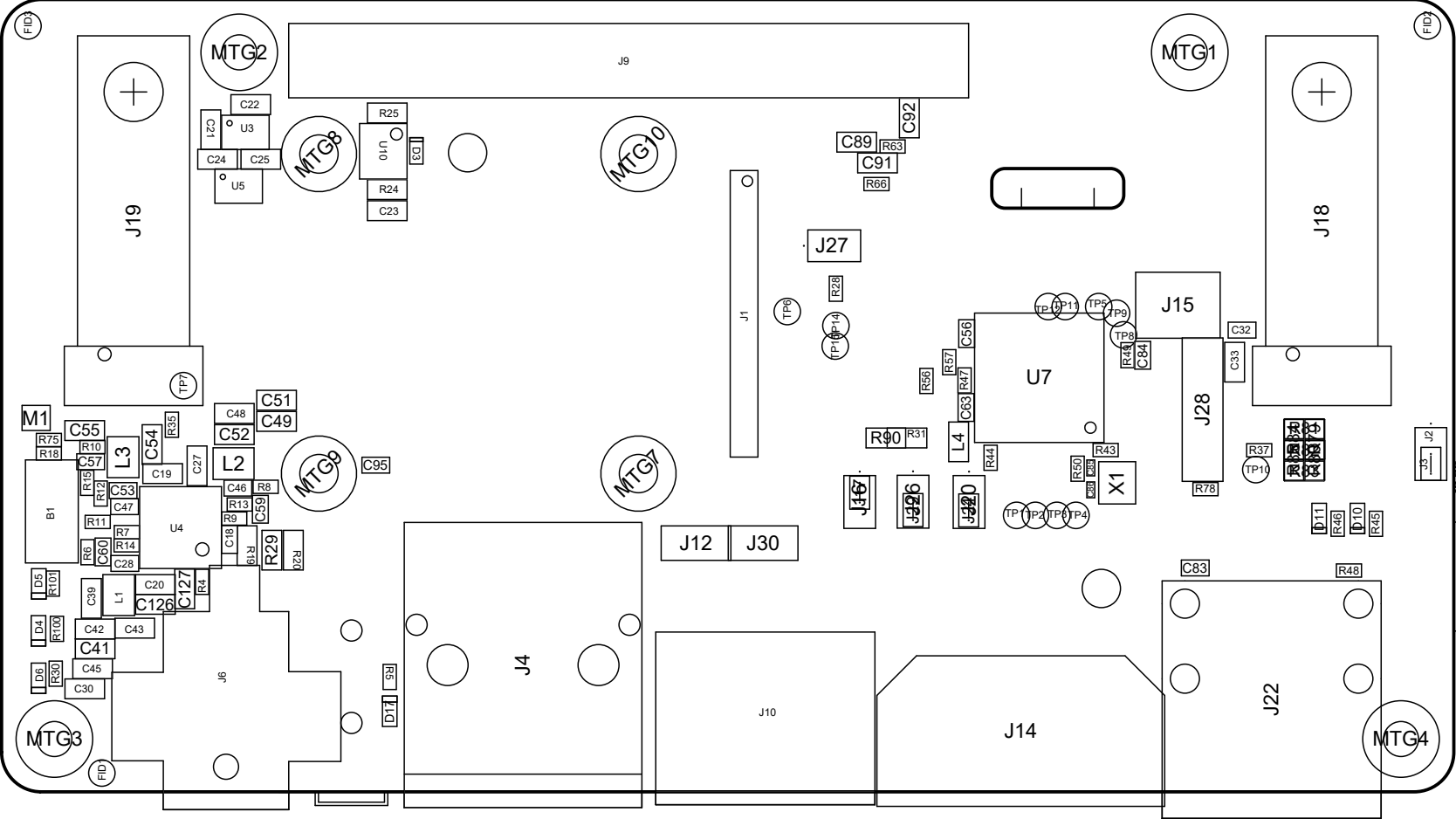
ASSEMBLY NOTES:

Assembly shall conform to IPC-A-610 Class 2.  
Assembly shall conform with RoHS Directive 2011/65/EU.  
Components shall be placed according to the associated CPL and BOM documents.  
Lead-free SAC305 solder shall be used.  
Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.  
BGA components shall be 100% checked with x-ray for solder bridges after reflow.  
Finished assemblies shall be removed from panel prior to delivery.

Notes:

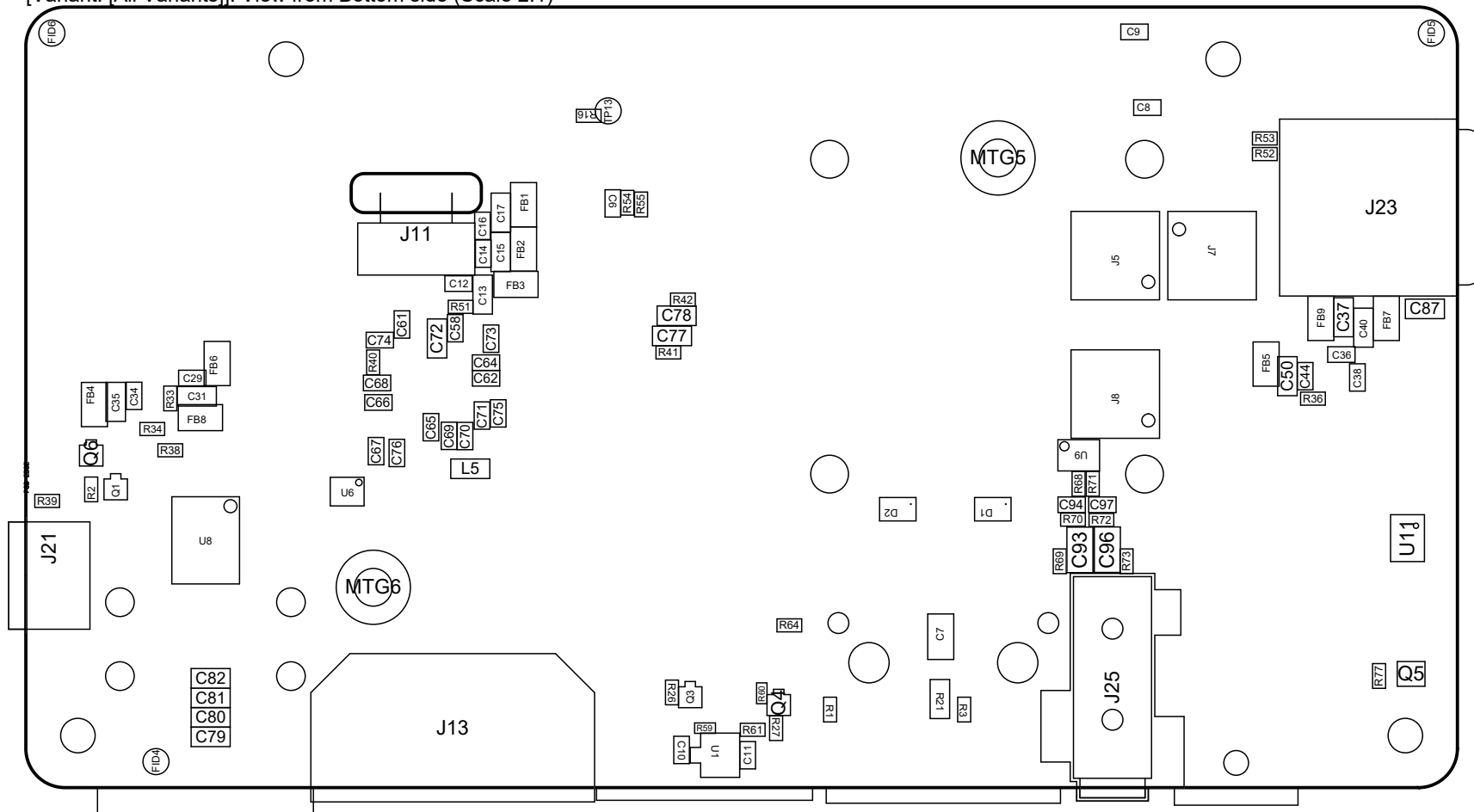
- 1
- Note 1: Receptacles for CM4 and J1 are the same (3pcs)
- 2
- Note 2: Last page is withot CM4
- 3
- Note 3


View from Top side (Scale 2:1)





[Variant: [All Variants]]: View from Bottom side (Scale 2:1)



Title: <b>DM1097</b>		
Number: D0000200	Revision: R2M0 E2	
Date: 31/08/2021	Sheet: 3 of 3	PROPRIETARY AND CONFIDENTIAL
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